

TOSHIBA Photocoupler Photorelay

TLP4176G

PBX

Telecommunication

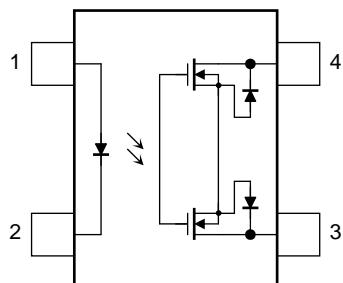
Modem FAX Cards, Modems In PC

Measurement Instrumentation

The TOSHIBA TLP4176GA consists of an aluminum gallium arsenide infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

The TLP4176GA is suitable for the modem applications which require space savings.

- 4 pin SOP (2.54SOP4): 2.1 mm high, 2.54 mm pitch
- 1-form-B
- Peak off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance: 25



1: ANODE

2: CATHODE

3: DRAIN

4: DRAIN

TOSHIBA 11-5H1

Weight: 0.1 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current	I _F	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Peak forward current (100 µs pulse, 100 pps)	I _{FP}	1	A
	Reverse voltage	V _R	5	V
	Junction temperature	T _j	125	°C

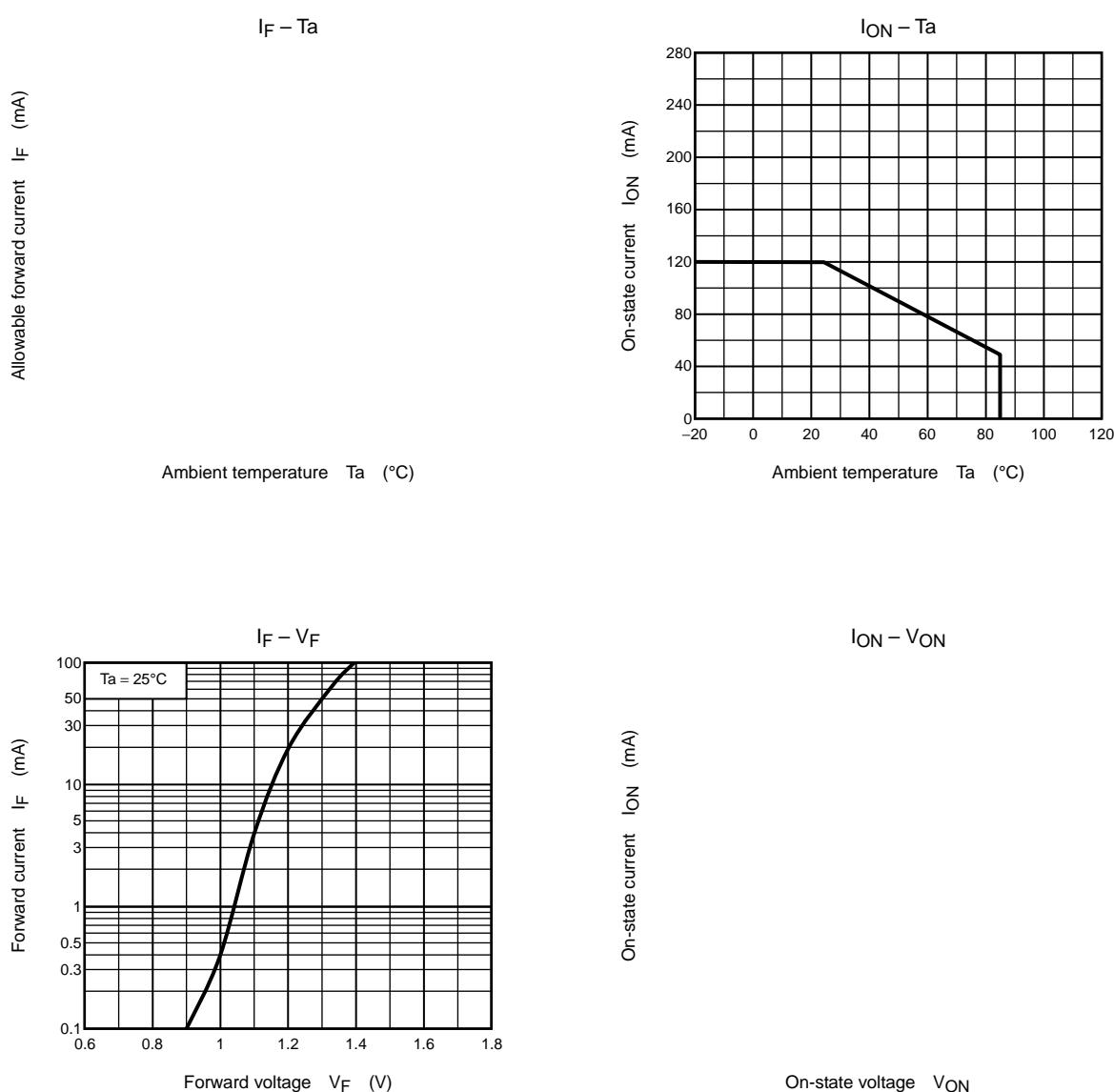
Off-state output terminal voltage Junction one 5f67.32 653865f67.334/TT8p2F8 0e0658862F849201720e2 ref299.7846e0ref28743081tag700.6A279

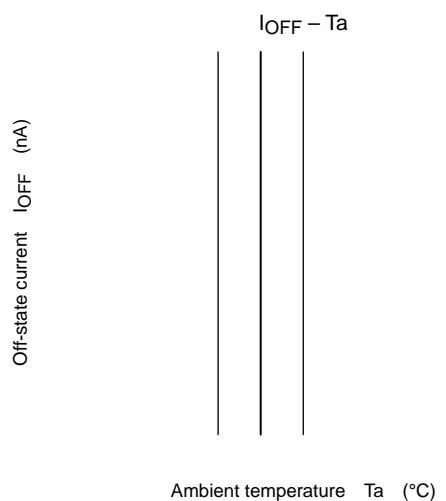
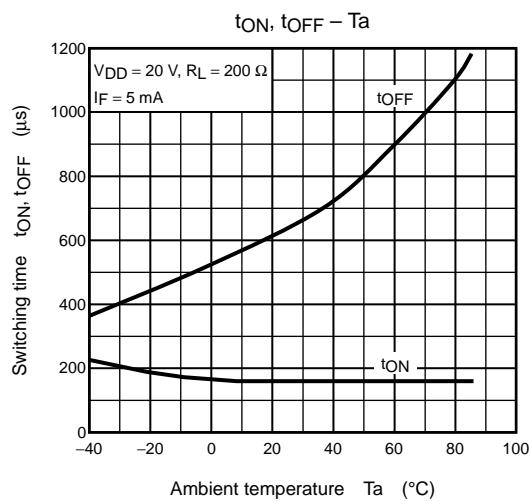
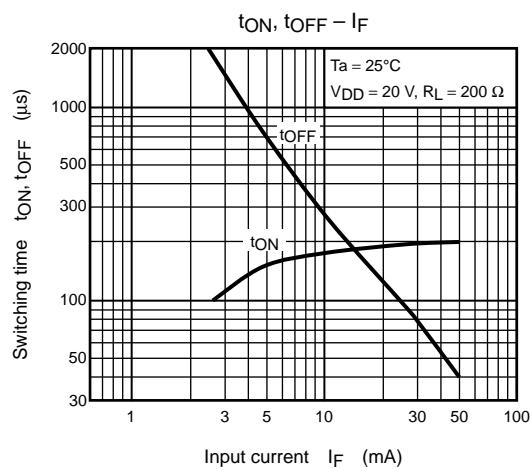
Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Trigger LED current	I _{FC}	I _{OFF} = 10 µA		1	3	mA
Return LED current	I _{FT}	I _{ON} = 120 mA	0.1			mA
On-state resistance	R _{ON}	I _{ON} = 120 mA		15	25	Ω

Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	0
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